

1.6X0.8mm SMD CHIP LED LAMP

Part Number: APT1608MGC

Mega Green

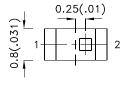
Features

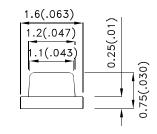
- 1.6mmX0.8mm SMT LED, 0.75mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package: 2000pcs / reel .
- Moisture sensitivity level : level 3.
- RoHS compliant.

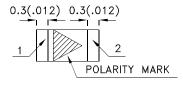
Description

The Mega Green source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.

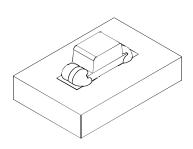
Package Dimensions











Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.1(0.004") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 4. The device has a single mounting surface. The device must be mounted according to the specifications.

SPEC NO: DSAA9053

REV NO: V.8

DATE: NOV/22/2010

PAGE: 1 OF 5 ERP: 1203001676

APPROVED: WYNEC CHECKED: Allen Liu

DRAWN: Y.H.Wu

Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
APT1608MGC	Mega Green (AlGaInP)	Water Clear	36	70	120°

- Notes: 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Mega Green	574		nm	IF=20mA
λD [1]	Dominant Wavelength	Mega Green	570		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Mega Green	26		nm	IF=20mA
С	Capacitance	Mega Green	20		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Mega Green	2.1	2.5	V	IF=20mA
lr	Reverse Current	Mega Green		10	uA	V _R =5V

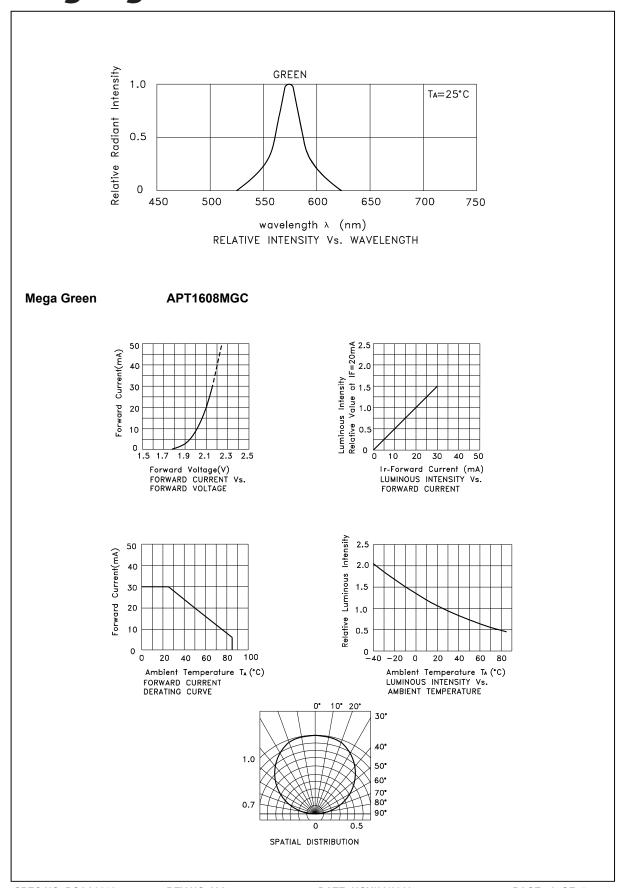
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

gg					
Parameter	Mega Green				
Power dissipation	75	mW			
DC Forward Current	30	mA			
Peak Forward Current [1]	150	mA			
Reverse Voltage	5 V				
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

SPEC NO: DSAA9053 **REV NO: V.8** DATE: NOV/22/2010 PAGE: 2 OF 5 APPROVED: WYNEC CHECKED: Allen Liu DRAWN: Y.H.Wu ERP: 1203001676



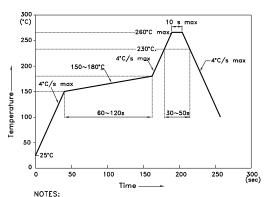
 SPEC NO: DSAA9053
 REV NO: V.8
 DATE: NOV/22/2010
 PAGE: 3 OF 5

 APPROVED: WYNEC
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 ERP: 1203001676

APT1608MGC

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



NOTES:

1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

3.Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

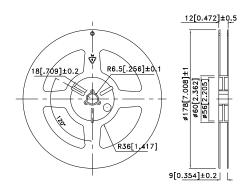
0.8

8.0

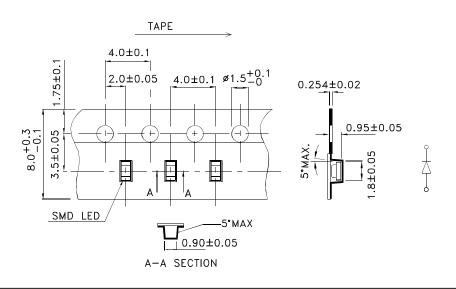
0.85

0.8

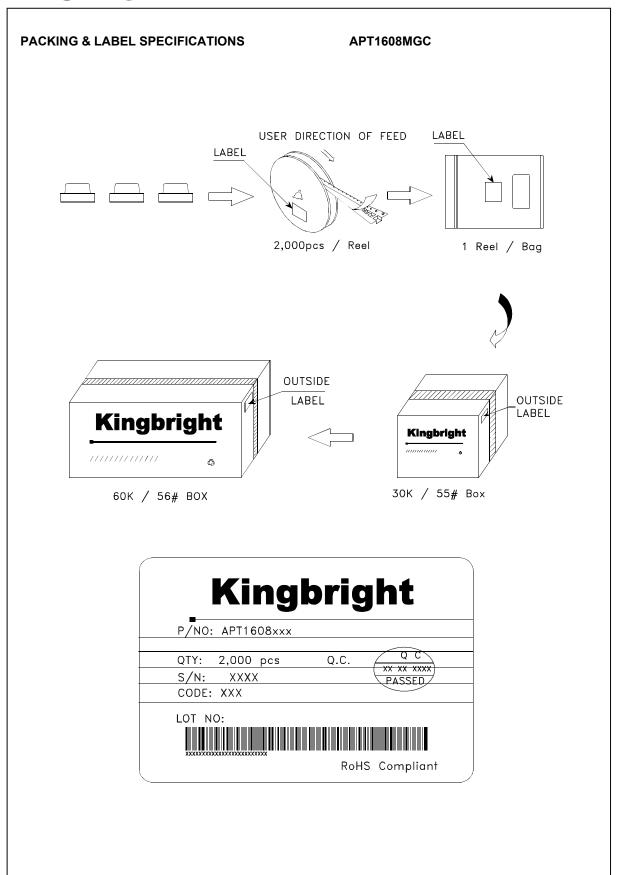
Reel Dimension



Tape Dimensions (Units: mm)



SPEC NO: DSAA9053 APPROVED: WYNEC REV NO: V.8 CHECKED: Allen Liu DATE: NOV/22/2010 DRAWN: Y.H.Wu PAGE: 4 OF 5 ERP: 1203001676



SPEC NO: DSAA9053 APPROVED: WYNEC REV NO: V.8 CHECKED: Allen Liu DATE: NOV/22/2010 DRAWN: Y.H.Wu PAGE: 5 OF 5 ERP: 1203001676